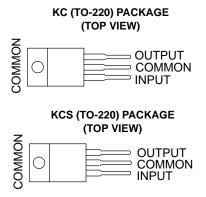
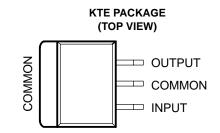
- ±1% Output Tolerance at 25°C
- ±2% Output Tolerance Over Full Operating Range
- Thermal Shutdown

- Internal Short-Circuit Current Limiting
- Pinout Identical to μA7800 Series
- Improved Version of μA7800 Series





description/ordering information

Each fixed-voltage precision regulator in the TL780 series is capable of supplying 1.5 A of load current. A unique temperature-compensation technique, coupled with an internally trimmed band-gap reference, has resulted in improved accuracy when compared to other three-terminal regulators. Advanced layout techniques provide excellent line, load, and thermal regulation. The internal current-limiting and thermal-shutdown features essentially make the devices immune to overload.

ORDERING INFORMATION

ТЈ	V _O TYP (V)	PACKAGE [†]		PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		Power Flex (KTE)	Reel of 2000	TL780-05CKTER	TL780-05C		
0°C to 125°C	12	TO-220 (KC)	Tube of 50	TL780-05CKC	TL780-05C		
		TO-220, short shoulder (KCS)	Tube of 20	TL780-05KCS	TL780-05		
		TO-220 (KC)	Tube of 50	TL780-12CKC	TL780-12C		
		TO-220, short shoulder (KCS)	Tube of 20	TL780-12KCS	TL780-12		
	15	TO-220 (KC)	Tube of 50	TL780-15CKC	TL780-15C		
	10	TO-220, short shoulder (KCS)	Tube of 20	TL780-15KCS	TL780-15		

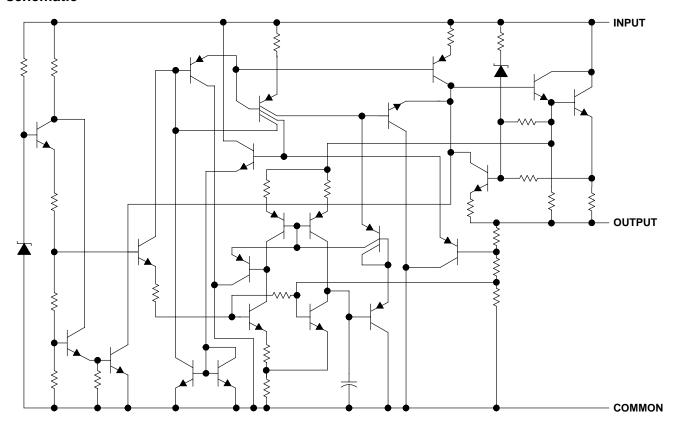
[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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schematic



absolute maximum ratings over operating temperature range (unless otherwise noted)†

Input voltage, V _I	35 V
Operating virtual junction temperature, T _J	150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq} –65°C to	150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

package thermal data (see Note 1)

PACKAGE	BOARD	θЈС	θ JA
Power Flex (KTE)	High K, JESD 51-5	3°C/W	23°C/W
TO-220 (KC/KCS)	High K, JESD 51-5	3°C/W	19°C/W

NOTE 1: Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection may be activated at power levels slightly above or below the rated dissipation.



recommended operating conditions

			MIN	MAX	UNIT
		TL780-05C	7	25	
٧ _I	Input voltage	TL780-12C	14.5	30	V
		TL780-15C	17.5	30	
IO Output current			1.5	Α	
TJ	Operating virtual junction temperature		0	125	°C

electrical characteristics at specified virtual junction temperature, V_I = 10 V, I_O = 500 mA (unless otherwise noted)

DADAMETED	TEST CONDITIONS	_ +	TL780-05C			UNIT
PARAMETER	TEST CONDITIONS	TJ [†]	MIN	TYP	MAX	UNII
Output valtage	$I_O = 5 \text{ mA to 1 A}, \qquad P \le 15 \text{ W},$ $V_I = 7 \text{ V to 20 V}$	W, 25°C	4.95	5	5.05	V
Output voltage		0°C to 125°C	4.9		5.1	
lanut voltage regulation	V _I = 7 V to 25 V	25°C		0.5	5	mV
Input voltage regulation	V _I = 8 V to 12 V	25°C		0.5	5	
Ripple rejection	V _I = 8 V to 18 V, f = 120	Hz 0°C to 125°C	70	85		dB
Outrot valte as negulation	I _O = 5 mA to 1.5 A	25°C		4	25	mV
Output voltage regulation	I _O = 250 mA to 750 mA	25-0		1.5	15	
Output resistance	f = 1 kHz	0°C to 125°C	0.0	035		Ω
Temperature coefficient of output voltage	$I_O = 5 \text{ mA}$	0°C to 125°C		0.25		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		75		μV
Dropout voltage	I _O = 1 A	25°C		2		V
Input bias current		25°C		5	8	mA
lanut bigg gurrant abanga	V _I = 7 V to 25 V	0°C to 105°C		0.7	1.3	^
Input bias-current change	I _O = 5 mA to 1 A	0°C to 125°C	0.	.003	0.5	mA
Short-circuit output current		25°C		750		mA
Peak output current		25°C		2.2		Α

[†] Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.22-μF capacitor across the output.

electrical characteristics at specified virtual junction temperature, V_I = 19 V, I_O = 500 mA (unless otherwise noted)

DADAMETED	TEST CONDITIONS	_ +	TL780-12C			LINUT
PARAMETER	TEST CONDITIONS	T√ţ	MIN	TYP	MAX	UNIT
Output voltage	$I_0 = 5 \text{ mA to 1 A}, P \le 15 \text{ W}$, 25°C	11.88	12	12.12	٧
Output voltage	V _I = 14.5 V to 27 V	0°C to 125°C	11.76		12.24	
Input voltage regulation	V _I = 14.5 V to 30 V	25°C		1.2	12	mV
Input voltage regulation	V _I = 16 V to 22 V	25 C		1.2	12	
Ripple rejection	V _I = 15 V to 25 V, f = 120 H	z 0°C to 125°C	65	80		dB
Output valta as as sulation	I _O = 5 mA to 1.5 A	25°C		6.5	60	mV
Output voltage regulation	I _O = 250 mA to 750 mA	25-0		2.5	36	
Output resistance	f = 1 kHz	0°C to 125°C	0.	0035		Ω
Temperature coefficient of output voltage	I _O = 5 mA	0°C to 125°C		0.6		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		180		μV
Dropout voltage	I _O = 1 A	25°C		2		V
Input bias current		25°C		5.5	8	mA
Input high ourrent change	V _I = 14.5 V to 30 V	0°C to 125°C		0.4	1.3	mA
Input bias-current change	I _O = 5 mA to 1 A	0 0 10 125 0		0.03	0.5	IIIA
Short-circuit output current		25°C		350		mA
Peak output current		25°C		2.2		Α

T Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-µF capacitor across the input and a 0.22-µF capacitor across the output.

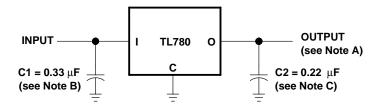
electrical characteristics at specified virtual junction temperature, V_I = 23 V, I_O = 500 mA (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T _J †	TL780-1	UNIT	
PARAMETER	TEST CONDITIONS		MIN TYP	MAX	UNII
Output voltage	$I_{O} = 5 \text{ mA to 1 A}, \qquad P \le 15 \text{ W},$	25°C	14.85 15	15.15	V
	V _I = 17.5 V to 30 V	0°C to 125°C	14.7	15.3	
Input voltage regulation	V _I = 17.5 V to 30 V	25°C	1.5	15	mV
input voitage regulation	V _I = 20 V to 26 V	25 C	1.5	15	
Ripple rejection	V _I = 18.5 V to 28.5 V, f = 120 Hz	0°C to 125°C	60 75	;	dB
Outrot valta na na sulation	I _O = 5 mA to 1.5 A	25°C	-	75	mV
Output voltage regulation	I _O = 250 mA to 750 mA	25 C	2.5	45	
Output resistance	f = 1 kHz	0°C to 125°C	0.003	;	Ω
Temperature coefficient of output voltage	I _O = 5 mA	0°C to 125°C	0.62	2	mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C	225	;	μV
Dropout voltage	I _O = 1 A	25°C	2	2	V
Input bias current		25°C	5.5	8	mA
Input bigg gurrent abanga	V _I = 17.5 V to 30 V	0°C to 125°C	0.4	1.3	mA
Input bias-current change	I _O = 5 mA to 1 A	0 C to 125 C	0.02	0.5	IIIA
Short-circuit output current		25°C	230)	mA
Peak output current		25°C	2.2	2	Α

[†] Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.22-μF capacitor across the output.



PARAMETER MEASUREMENT INFORMATION



NOTES: A. Permanent damage can occur when OUTPUT is pulled below ground.

- B. C1 is required when the regulator is far from the power-supply filter.
- C. C2 is not required for stability; however, transient response is improved.

Figure 1. Test Circuit

APPLICATION INFORMATION

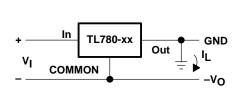
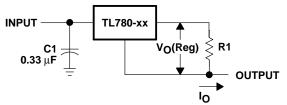


Figure 2. Positive Regulator in Negative Configuration (V_I Must Float)



IO = (VO/R1) + IO Bias Current

Figure 3. Current Regulator

operation with a load common to a voltage of opposite polarity

In many cases, a regulator powers a load that is not connected to ground, but instead, is connected to a voltage source of opposite polarity (e.g., operational amplifiers, level-shifting circuits, etc.). In these cases, a clamp diode should be connected to the regulator output as shown in Figure 4. This protects the regulator from output polarity reversals during startup and short-circuit operation.

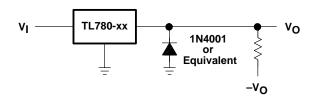


Figure 4. Output Polarity-Reversal-Protection Circuit

reverse-bias protection

Occasionally, the input voltage to the regulator can collapse faster than the output voltage. This, for example, could occur when the input supply is crowbarred during an output overvoltage condition. If the output voltage is greater than approximately 7 V, the emitter-base junction of the series pass element (internal or external) could break down and be damaged. To prevent this, a diode shunt can be employed, as shown in Figure 5.

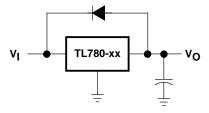
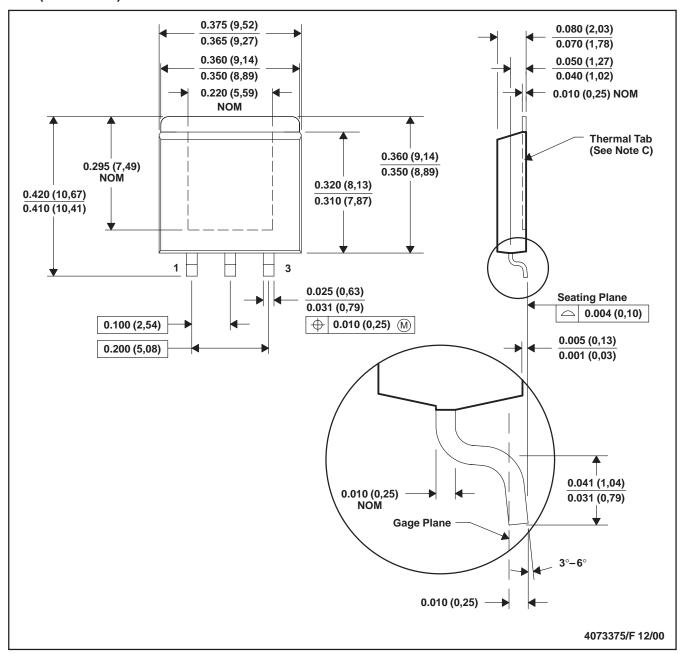


Figure 5. Reverse-Bias-Protection Circuit



KTE (R-PSFM-G3)

PowerFLEX™ PLASTIC FLANGE-MOUNT



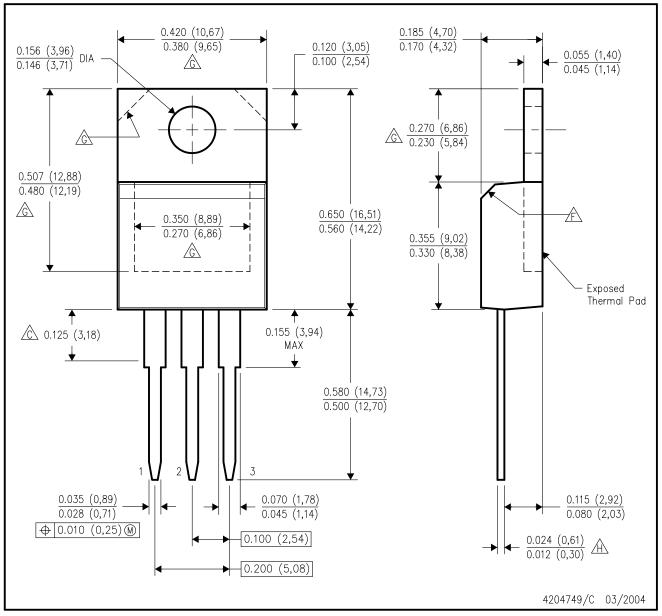
- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. The center lead is in electrical contact with the thermal tab.
 - D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
 - E. Falls within JEDEC MO-169

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KCS (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



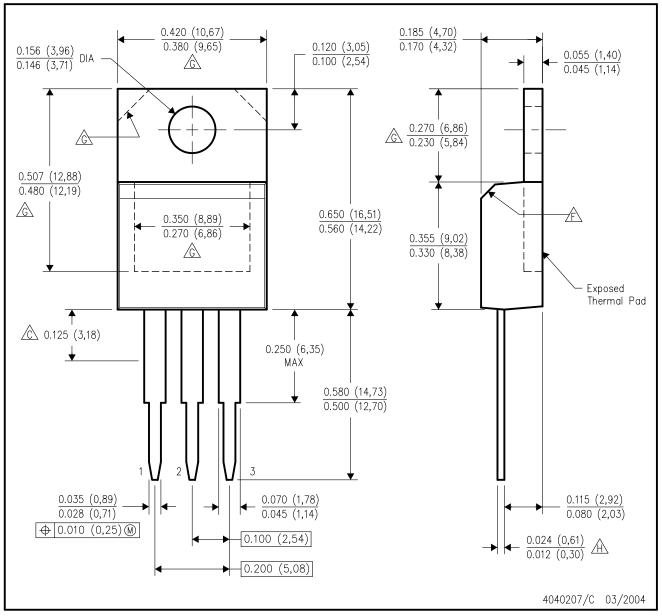
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- The chamfer is optional.
- Thermal pad contour optional within these dimensions.
- Falls within JEDEC TO-220 variation AB, except minimum lead thickness.



KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- The chamfer is optional.
- Thermal pad contour optional within these dimensions.
- Falls within JEDEC TO-220 variation AB, except minimum lead thickness.



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